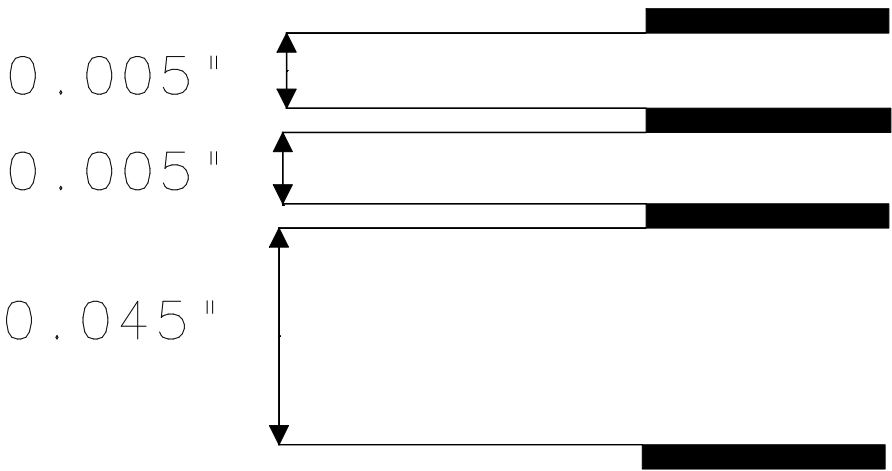


BOARD's DRILL SCHEDULE

DRILL SYMBOL	DRILL SIZE	COUNT	PLATED	Tolerance	COMMENT
○	.014 "	110	YES	---	
⊞	.041 "	6	YES	---	
⊕	.05 "	100	YES	---	

Layer Order
4-Layer Flex PCB – 90x53mm, 0.062" Thick



- Film 1 – Top
- Film 2 – Power
- Film 3 – Signal 3
- Film 4 – Bottom

Board Characteristics

- 0. Material – RF4 – Tg >170C
- 2. Minimum trace width: 5 mils
- 3. 1 Oz Copper on all layers
- 4. Silkscreen on Component Side.
- 5. ~~Polyimide Coverlay (Kapton Soldermask)~~ on Top and Bottom, as per Gerbers
- 6. Soft Au finish (ENIG) .

<div>UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES .XX .XXX DO NOT SCALE DRAWING</div>	CONTRACT NO.	UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP			
	APPROVALS	DATE	TITLE 6Kx4K CCD Intermediate Board Specification Drawing		
TREATMENT	DRAWN M. Bogdan	11/1/2020			
FINISH	CHECKED M. Bogdan	11/1/2020	SIZE	FSCM NO.	DWG. NO. 2962
	ISSUED				REV. A
SIMILAR TO	ACT. WT	CALC WT	SCALE 1 / 1		SHEET